

RSJ650N10TL-VB Datasheet N-Channel 100 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A)		
100	0.004 at V _{GS} = 10 V	140 ^a		

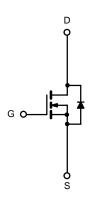
FEATURES

- Trench Power MOSFET
- New Package with Low Thermal Resistance
- 100 % R_g Tested









N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _C = 25 °C, unless otherwise noted						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	V _{DS}	100	V			
Gate-Source Voltage	V _{GS}	± 20				
Continuous Drain Current (T. – 175 °C)	T _C = 25 °C		140 ^a	Α		
Continuous Drain Current (T _J = 175 °C)	T _C = 125 °C	I _D	87 ^a			
Pulsed Drain Current	I _{DM}	440	A			
Avalanche Current	I _{AR}	75				
Repetitive Avalanche Energy ^b	L = 0.1 mH	E _{AR}	280	mJ		
Maximum Power Dissipation ^b	T _C = 25 °C	D	375 ^c	W		
waximum rowei bissipation	T _A = 25 °C	P _D	3.75	T vv		
Operating Junction and Storage Temperature	Range	T _J , T _{stg}	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Limit	Unit			
Junction-to-Ambient	PCB Mount (TO-263) ^d	R _{thJA}	40	°C/W			
Junction-to-Case (Drain)		R _{thJC}	0.4	C/VV			

Notes:

- a. Package limited.
- b. Duty cycle ≤ 1 %.
- c. See SOA curve for voltage derating.
 d. When mounted on 1" square PCB (FR-4 material).

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	•			•			
Drain-Source Breakdown Voltage	V _{DS}	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	100			V	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2		4		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		V _{DS} = 100 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V, T _J = 125 °C			50	μA	
		V _{DS} = 100 V, V _{GS} = 0 V, T _J = 175 °C			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	120			Α	
		V _{GS} = 10 V, I _D = 30 A		0.004			
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 30 A, T _J = 125 °C		0.017		Ω	
		V _{GS} = 10 V, I _D = 30 A, T _J = 175 °C		0.025		1	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	25			S	
Dynamic ^b							
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		5500		pF	
Output Capacitance	C _{oss}			750			
Reverse Transfer Capacitance	C _{rss}			280			
Total Gate Charge ^c	Qg			110	160		
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 85 \text{ A}$		24		nC	
Gate-Drain Charge ^c	Q _{gd}			24			
Gate Resistance	R _g		1.0		6.2	Ω	
Turn-On Delay Time ^c	t _{d(on)}			20	30		
Rise Time ^c	t _r	$V_{DD} = 50 \text{ V}, R_{L} = 0.6 \Omega$		125	200	20	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 85 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		55	85	ns	
Fall Time ^c	t _f			130	195		
Source-Drain Diode Ratings and Cha	aracteristics -	Γ _C = 25 °C ^b		•			
Continuous Current	I _S				140	^	
Pulsed Current	I _{SM}				240	Α	
Forward Voltage ^a	V _{SD}	I _F = 85 A, V _{GS} = 0 V		1.0	1.5	V	
Reverse Recovery Time	t _{rr}			70	140	ns	
Peak Reverse Recovery Charge	I _{RM(REC)}	I _F = 50 A, dl/dt = 100 A/μs		5.5	10	Α	
Reverse Recovery Charge	Q _{rr}			0.19	0.35	μC	

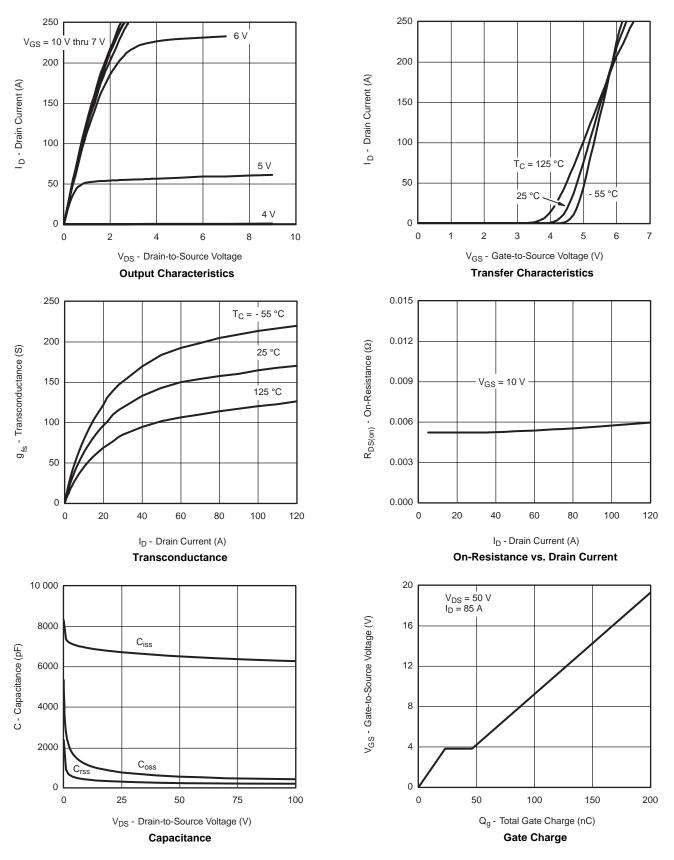
Notes:

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



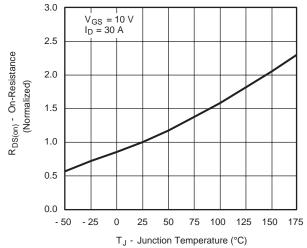
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



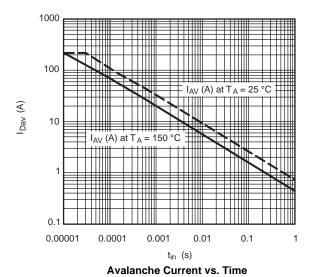
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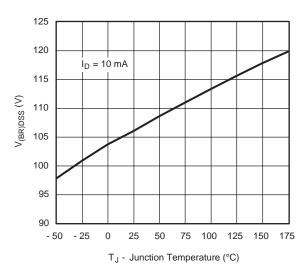
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On-Resistance vs. Junction Temperature



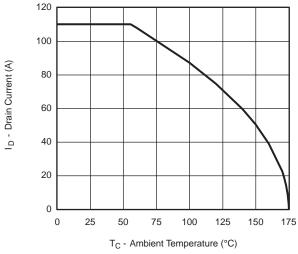
Source-Drain Diode Forward Voltage

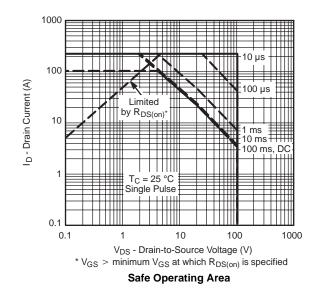


Drain Source Breakdown vs. Junction Temperature

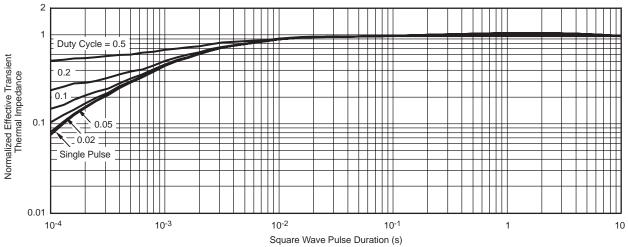


THERMAL RATINGS





Maximum Avalanche and Drain Current vs. Case Temperature

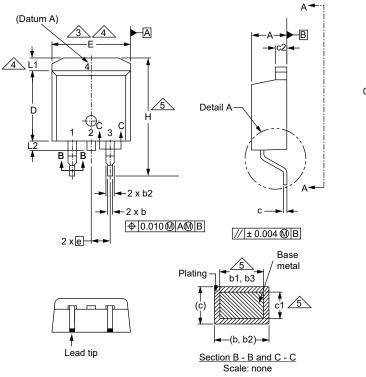


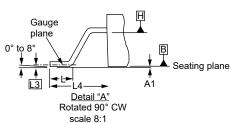
Normalized Thermal Transient Impedance, Junction-to-Case

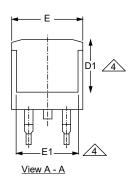
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TO-263AB (HIGH VOLTAGE)







	MILLIN	METERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	4.06	4.83	0.160	0.190	
A1	0.00	0.25	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	
c2	1.14	1.65	0.045	0.065	

9.65

0.330

0.380

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D1	6.86	-	0.270	-
Е	9.65	10.67	0.380	0.420
E1	6.22	-	0.245	-
е	2.54 BSC		0.100 BSC	
Н	14.61	15.88	0.575	0.625
L	1.78	2.79	0.070	0.110
L1	-	1.65	-	0.066
L2	-	1.78	-	0.070
L3	0.25 BSC		0.010 BSC	
L4	4.78	5.28	0.188	0.208

8.38 ECN: S-82110-Rev. A, 15-Sep-08

DWG: 5970

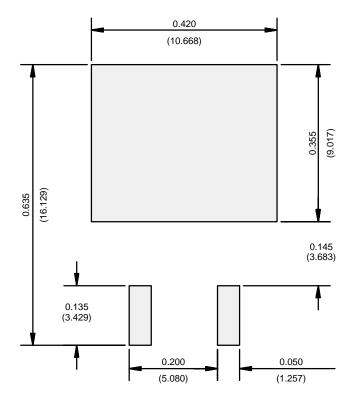
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- 1. Dimensioning and tolerancing per ASME Y14.5M-2018.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.

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RECOMMENDED MINIMUM PADS FOR D2PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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